

客户 (Customer) : _____

承认书

Approval Sheet

谨致执事者：兹提供敝公司之有关详细规格及图面数据,敬请给予办理试认定手续。
同时敬请送返一份附有贵公司签认之测试认定后之样品承认书。

We are pleased in sending you herewith on specification and drawings for your approval.
Please return to us one copy "Approval sheet" with your approved signature.

型号 (Model No.) : A-SL686W1D-C01-4T(HW)

发文日期 (Issue Date) : 2020/12/16 承认日期 (Approved Date) : _____

Checking signature of Amicc

Designer	Checker	Approver
Allen	<i>Tommy</i>	Solarliu

Approval signature of customer

Designer	Checker	Approver

江苏欧密格光电科技股份有限公司

Jiangsu Amicc Opto-Electronics Technology Co.,Ltd.

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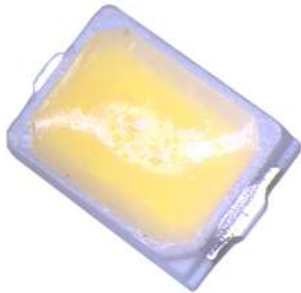
TEL:0086-519-89806999

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Mono-Color Type ▪ Top view 2016 package

A-SL686W1D-C01-4T(HW)



■ Description

The Amicc 686 package has high efficacy, low power consumption, wide viewing angle and a compact form factor. These features make this package to be an ideal LED for all lighting applications.

■ Features

- Top view LED
- High Luminous Intensity output
- Wide viewing angle
- Pb-free
- RoHS compliant
- JEDEC MSL 3

■ Applications

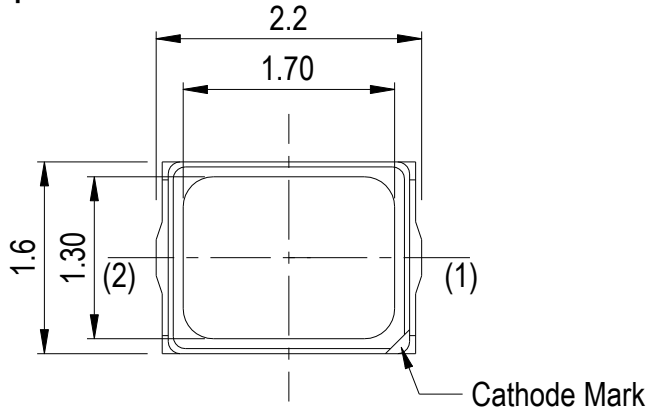
- Mobile Phone Camera Flash
- Decorative and Entertainment Lighting
- Signal and symbol luminaries for orientation marker lights
- TFT backlighting
- Indoor lighting application
- Torch light for DV application
- Exterior and interior automotive illumination

■ Device Selection Guide

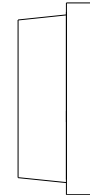
Chip Materials	Emitted Color	Resin Color
InGaN	Nature White	Yellow Diffused

■ Package Dimensions

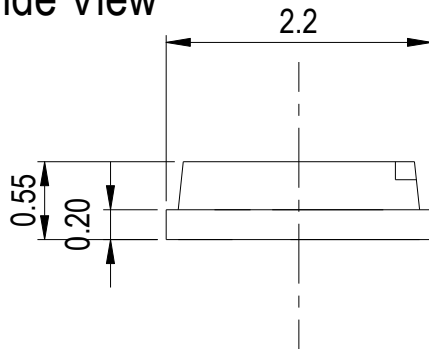
Top View



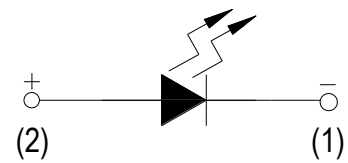
Side View



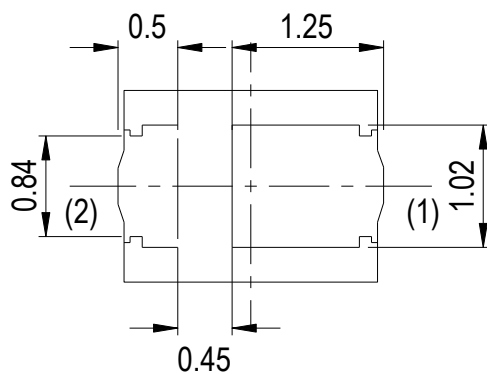
Side View



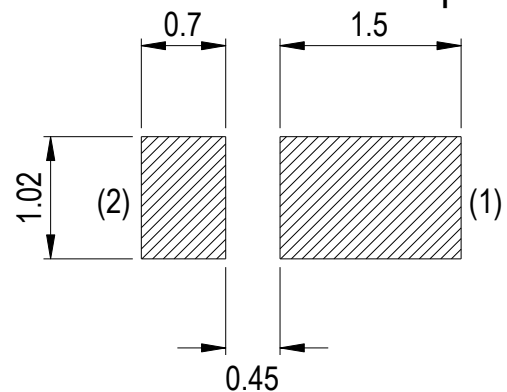
Polarity



Bottom View



Recommended Solder pad



Note:
 Tolerance without mention is ± 0.1 mm.

■ **Absolute Maximum Ratings (T_{Soldering}=25°C)**

Parameter	Symbol	Rating	Unit
Forward Current	I _F	30	mA
Peak Forward Current (Duty 1/10 @1ms)	I _{FP}	100	mA
Power Dissipation	P _d	90	mW
Reverse Voltage	V _R	7	V
Operating Temperature	T _{opr}	-40 ~ +100	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Electrostatic Discharge(HBM)	ESD	500	V
Junction Temperature	T _j	120	°C
Soldering Temperature	T _{sol}	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

■ **Electro-Optical Characteristics (T_{Soldering}=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Φ	500	600	700	mcd	I _F =5mA
Forward Voltage	V _F	2.5	2.8	3.0	V	I _F =5mA
Color Temperature	CCT	5700	6100	6650	K	I _F =5mA
Color Rendering Index	CRI	-----	70	-----		I _F =5mA
Viewing Angle	2θ _{1/2}	-----	120	-----	deg	I _F =5mA
Reverse Current	I _R	-----	-----	10	μA	V _R =5V

Notes:

1. Tolerance of Luminous Intensity: ±10%.
2. Tolerance of Forward Voltage : ±0.05V.

■ **Bin Range of Luminous Intensity**

Bin Code	Min.	Max.	Unit	Condition
AU11	500	550	mcd	I _F =5mA
AU12	550	600		
AU21	600	650		
AU22	650	700		

Note:
 Tolerance of Luminous Intensity: ±10%.

■ **Bin Range of Forward Voltage**

Bin Code	Min.	Max.	Unit	Condition
32	2.5	2.6	V	I _F =5mA
33	2.6	2.7		
34	2.7	2.8		
35	2.8	2.9		
36	2.9	3.0		

Note:
 Tolerance of Forward Voltage: ±0.05V.

■ **Bin Range of Chromaticity Coordinates**

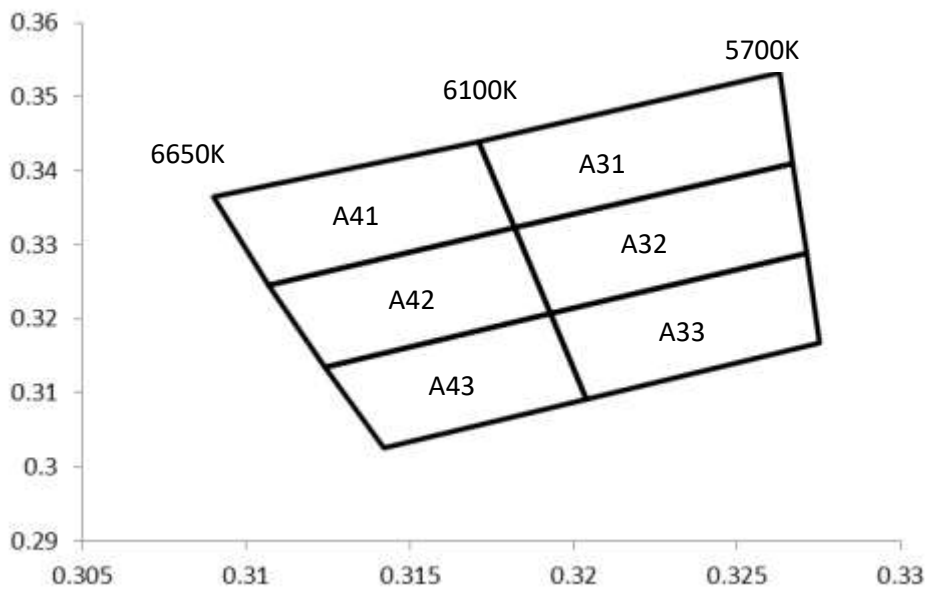
Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
A31	0.3171	0.3440	A32	0.3182	0.3324
	0.3263	0.3532		0.3267	0.3410
	0.3267	0.3410		0.3271	0.3289
	0.3182	0.3324		0.3193	0.3208
A33	0.3193	0.3208			
	0.3271	0.3289			
	0.3275	0.3167			
	0.3204	0.3092			

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
A41	0.3090	0.3365	A42	0.3107	0.3245
	0.3171	0.344		0.3182	0.3324
	0.3182	0.3324		0.3193	0.3208
	0.3107	0.3245		0.3124	0.3135
A43	0.3124	0.3135			
	0.3193	0.3208			
	0.3204	0.3092			
	0.3142	0.3025			

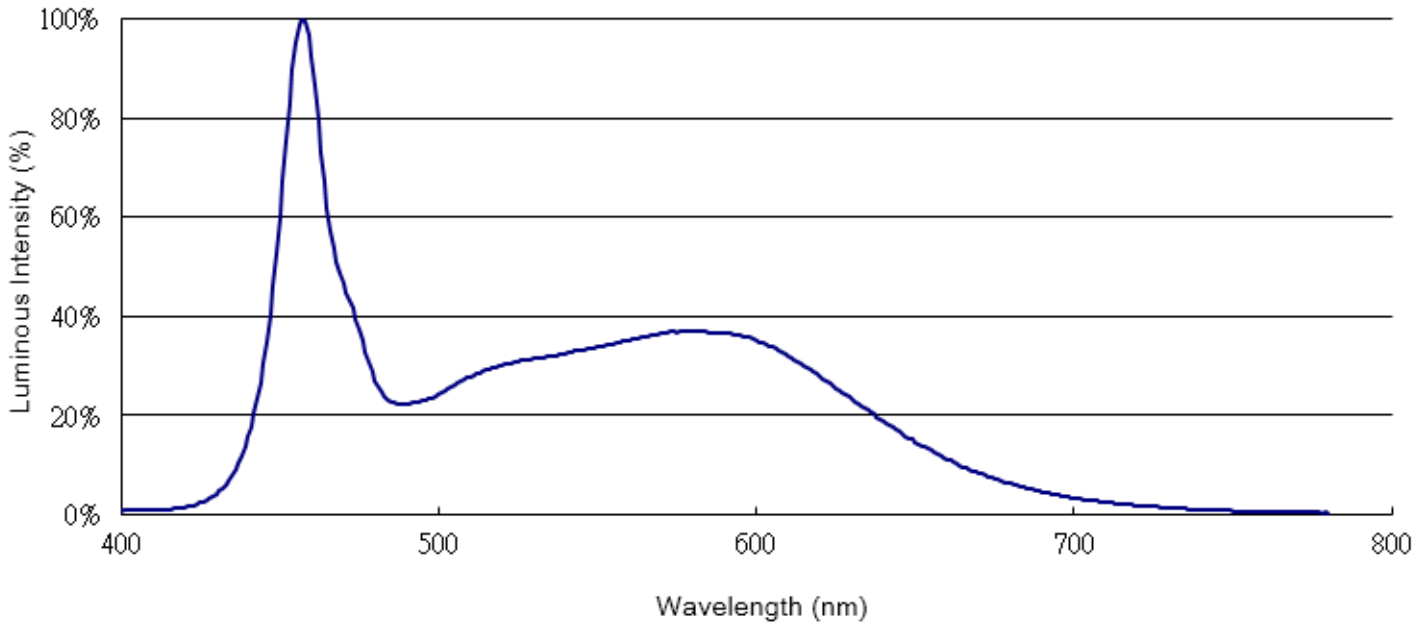
Notes:

1. The value is based on driving current by 5mA.
2. Tolerance of Chromaticity Coordinates: ± 0.01 .

■ The C.I.E. 1931 Chromaticity Diagram



■ Spectrum Distribution



■ Typical Electro-Optical Characteristics Curves

Fig.1-Forward Voltage Shift vs. T_j-Junction Temperature

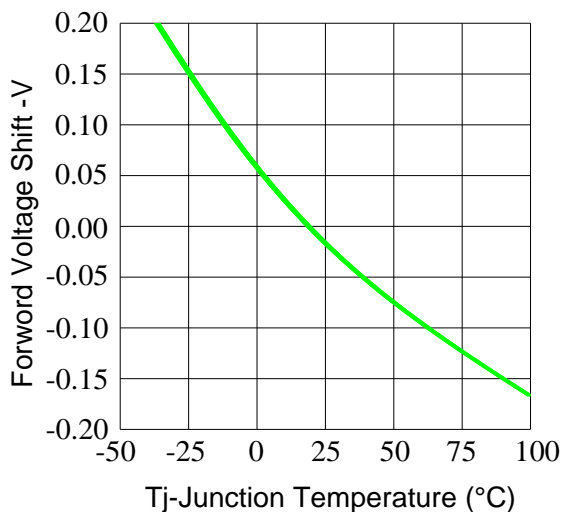
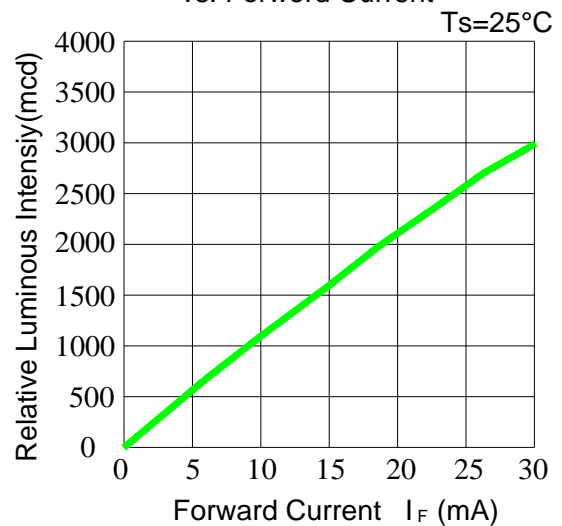


Fig.2- Luminous Intensity vs. Forward Current
T_s=25°C



■ Typical Electro-Optical Characteristics Curves

Fig.3-Relative Luminous Flux vs.Tj-Junction Temperature

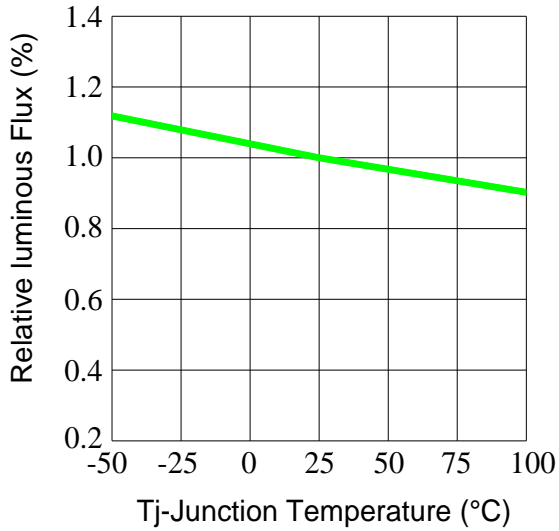


Fig.4-Forward Current vs. Forward Voltage Ta=25°C

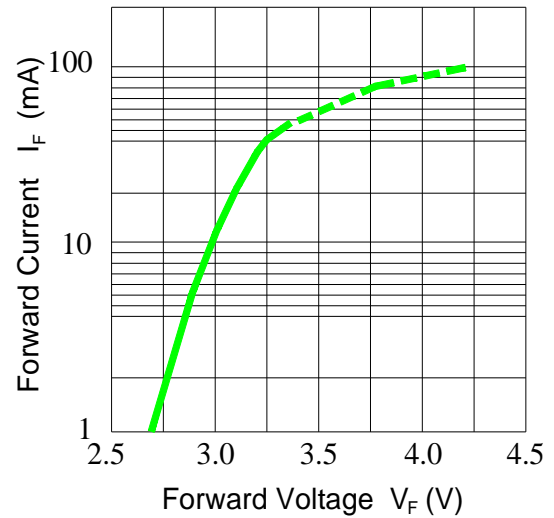


Fig.5-Max.Driving Forward Current vs.Soldering Temperature

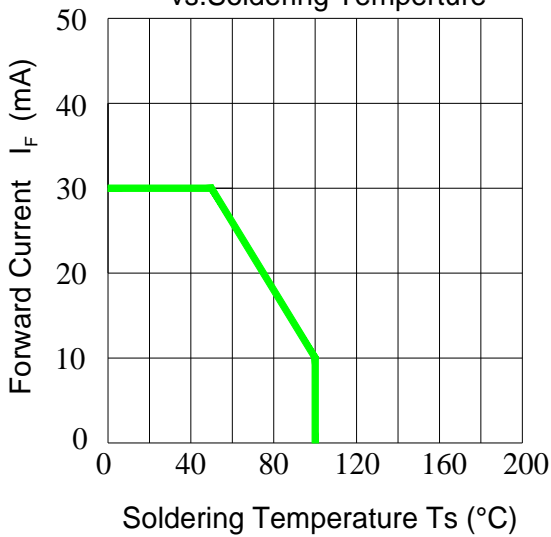
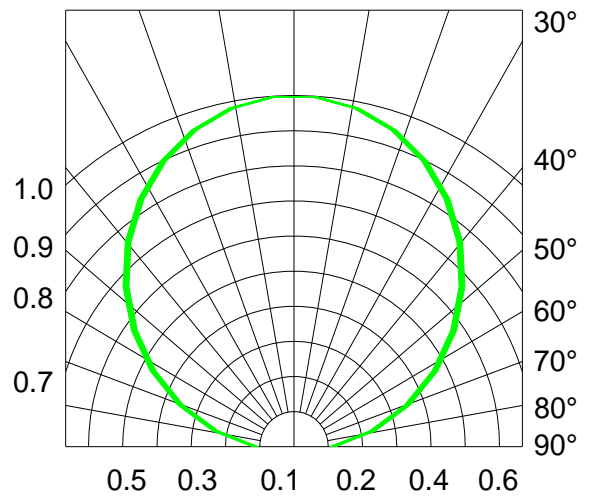
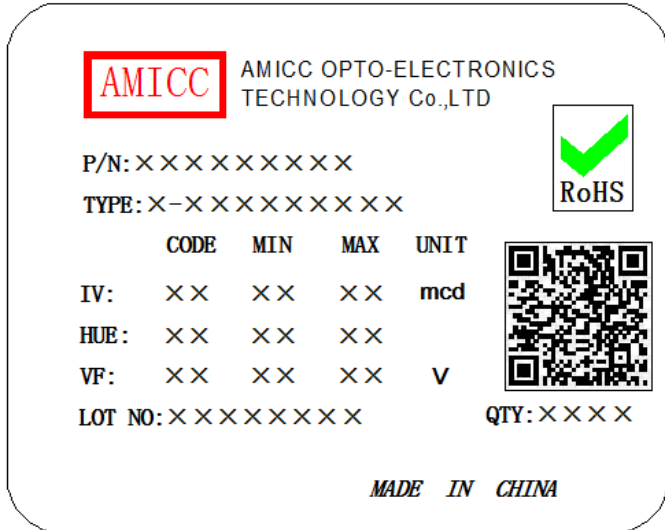


Fig.6-Radiation Diagram Ta=25°C



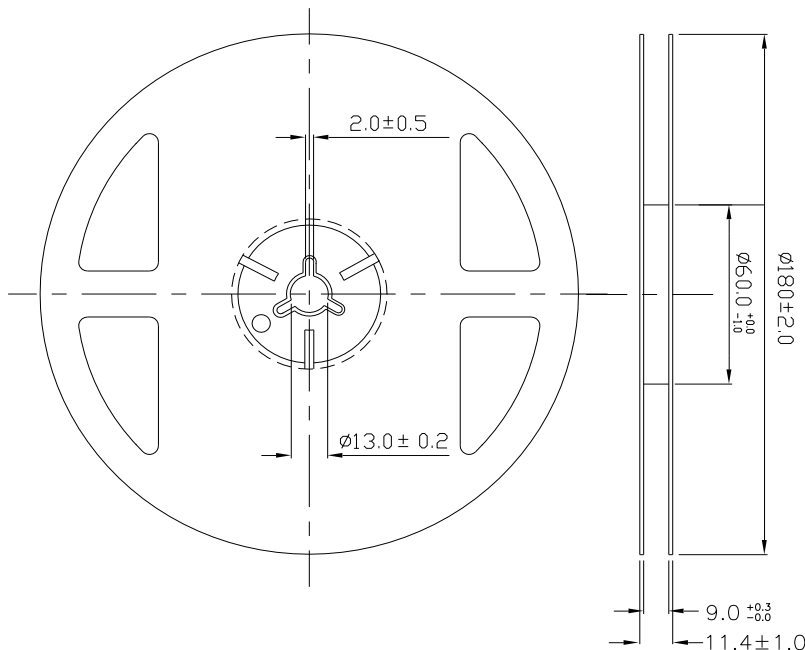
■ **Moisture Resistant Packing Materials**

1. **Label Explanation**



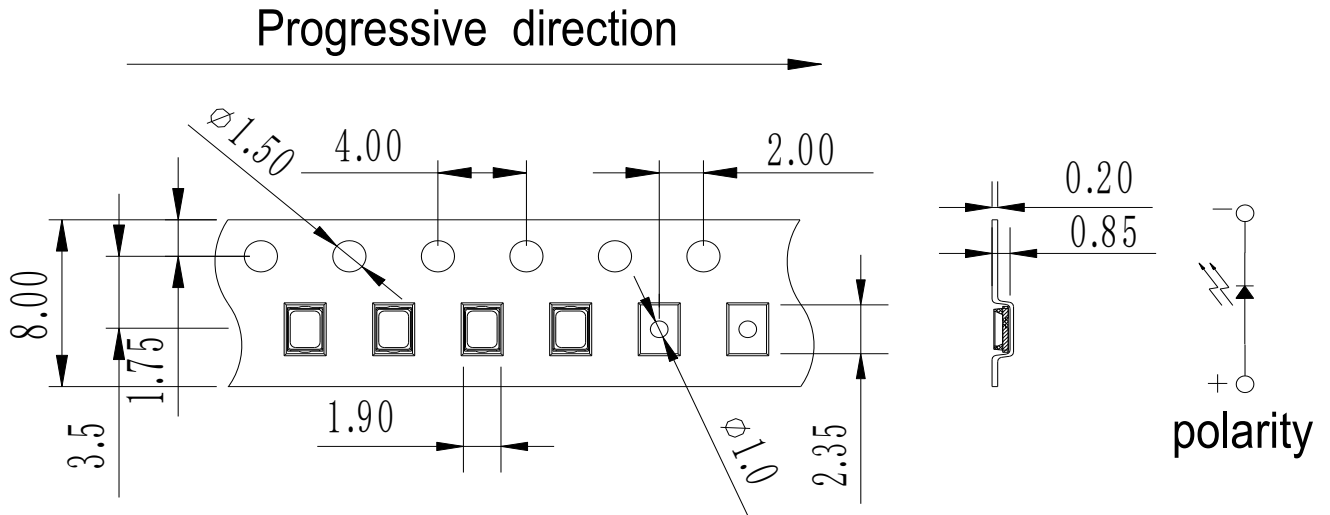
- CPN: Customer's Product Number
- P/N: Product Number
- TYPE: Part NO.
- IV: Luminous Intensity Rank
- HUE: Chromaticity Coordinates Rank
- VF: Forward Voltage Rank
- LOT No: Lot Number
- QTY: Packing Quantity

2. **Reel Dimensions**



Note:
 Tolerance without mention is ± 0.1 mm.

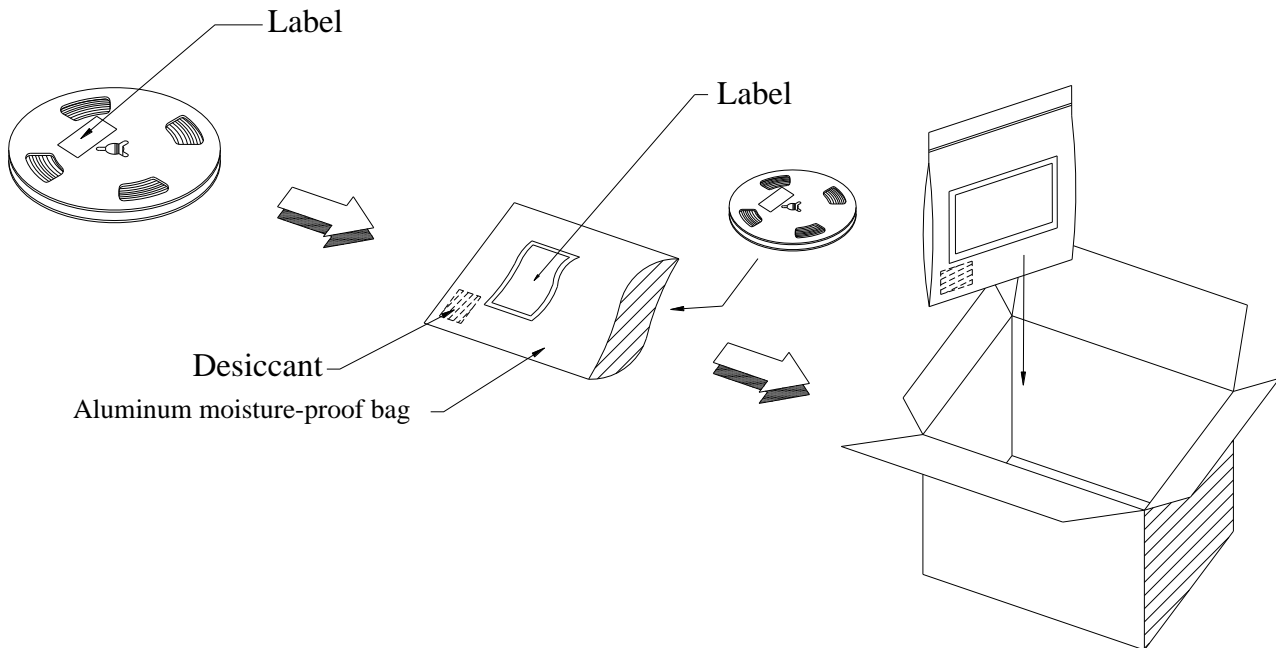
3. Carrier Tape Dimensions: Loaded Quantity 4000 pcs Per Reel



Notes:

- 1. Tolerance without mention is ± 0.1 mm.
- 2. Minimum packing quantity is 1000 pcs per reel.

4. Moisture Resistant Packing Process



■ Precautions for Use

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

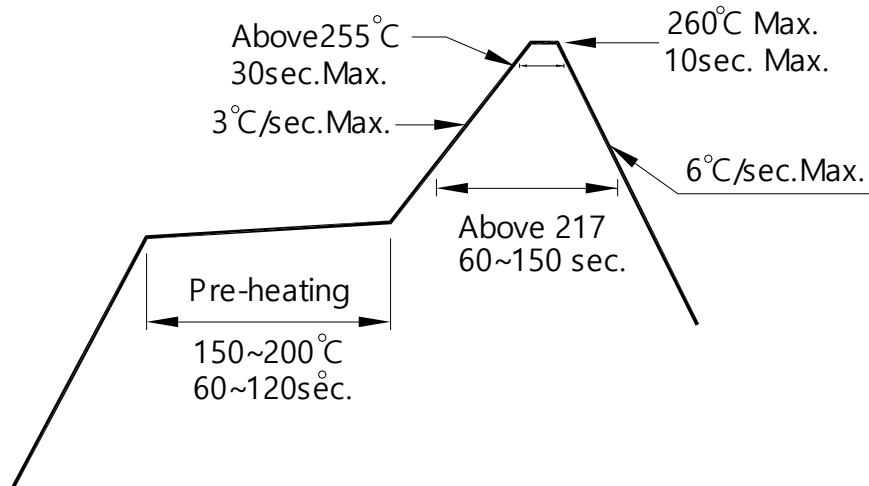
2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 168 hours under 30°C or less and 60% RH or less (MSL3) .
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering could endure three times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

